

Supplementary Material for

Modulating the resistive switching stability of HfO₂-based RRAM through Gd doping engineering: DFT+U

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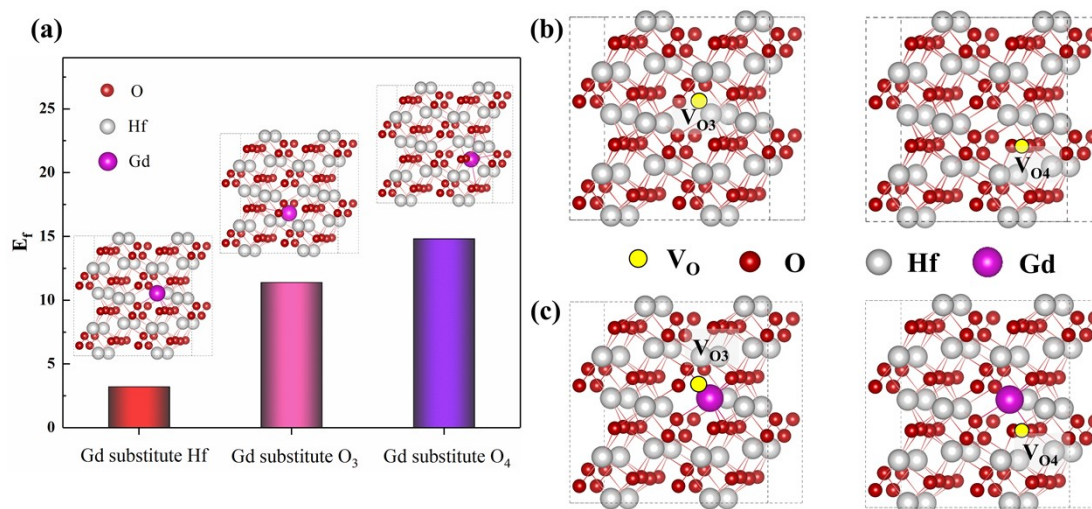


Fig. S1 (a) The doping formation energy of Gd-doped HfO₂ system and the configurations of HfO₂ with single V_O (b) before and (c) after Gd doping.

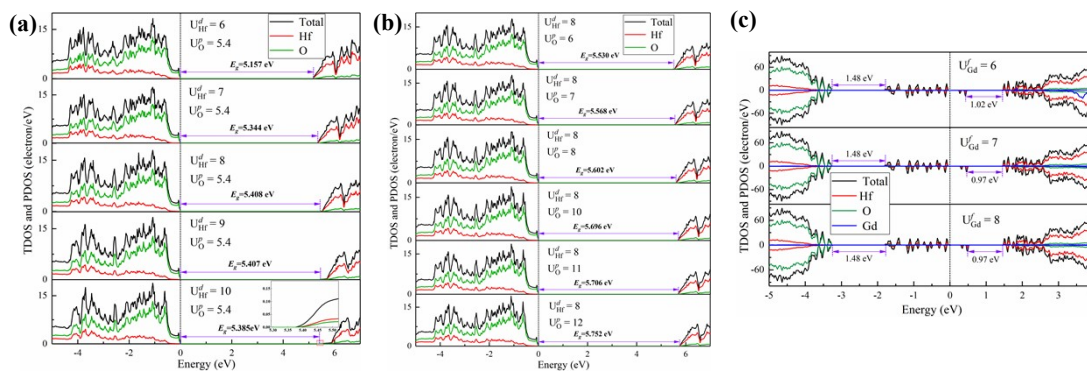


Fig. S2 The density of states calculated with (a) different U^d and a fixed $U^p = 5.4$ eV, (b) different U^p and a fixed $U^d = 8$ eV and (c) different U^f and a fixed $U^d = 8$ eV, a fixed $U^p = 10$ eV.

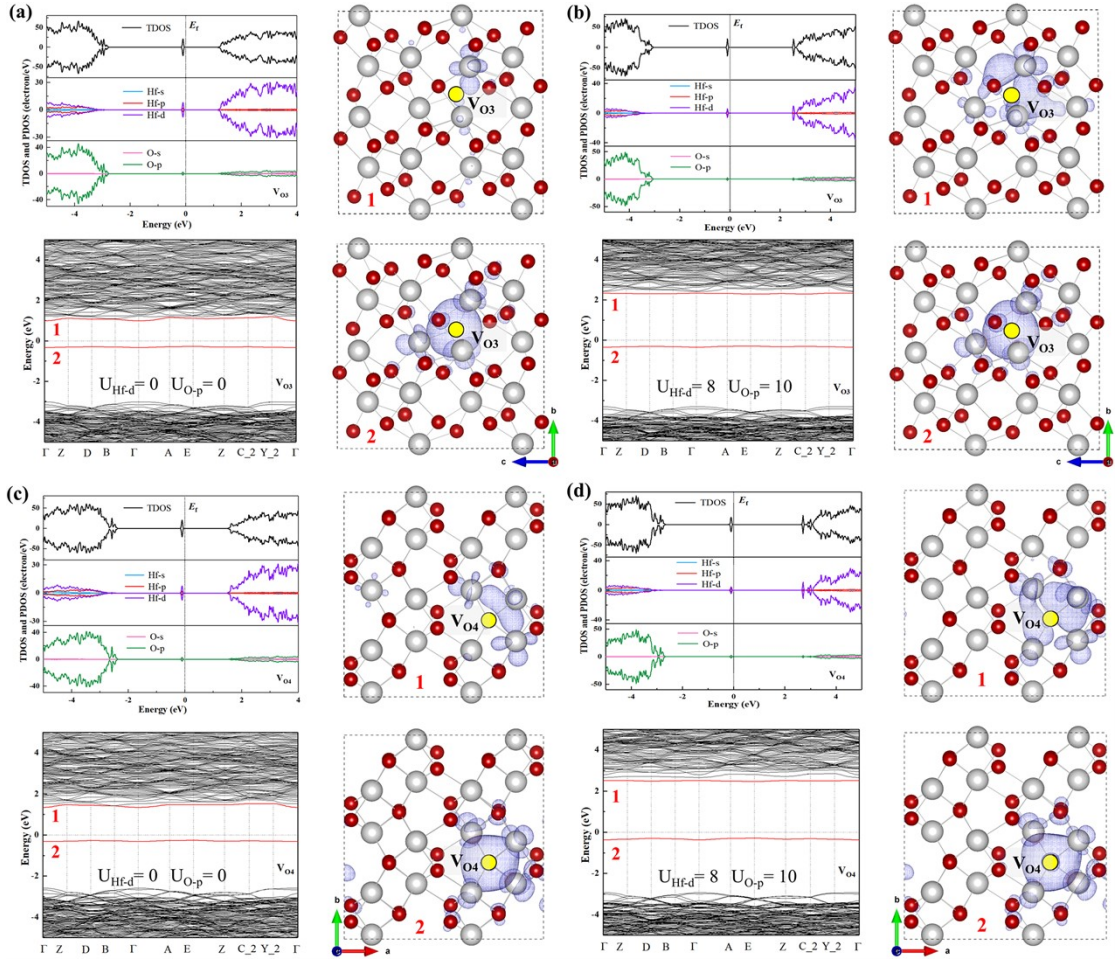


Fig. S3 The electronic structures of m -HfO₂ containing (a) and (b) single V_{O3} and (c) and (d) single V_{O4} before and after the applying U^d and U^p value.

To further analyse the changes in the characteristics of the chemical bonding before and after Gd doping, we have analyzed the electron localization function (ELF) distributions, as shown in Fig. S4 below. The ELF value is between 0 and 1, with the upper limit value ELF=1 meaning complete electron localization, the lower limit value ELF=0 meaning complete electron delocalization or no electron, and the middle value ELF=1/2 meaning the electron-gas-like pair probability. It can be seen from Fig. S4 that compared with perfect HfO₂ (Figs. (a) and (d)), when the system contains V_O (Figs. (b) and (e)), there will be obvious electron localization around the V_O, and when Gd is doped (Figs. (c) and (f)), the electrons are not only localized around the V_O, but also around the dopant Gd. There is an obvious charge interaction between Gd and its surrounding O atoms, with the Hf-O bond replaced by a Gd-O bond. The charge state of Gd and the surrounding O atoms also changes significantly compared to that before Gd doping, which will inevitably cause distortion of the local geometry, as shown in Fig. 4 in the manuscript. These results further indicate that Gd doping can cause local distortion of the geometrical configuration, strengthen the charge interaction between atoms, and improve the conductivity of the system.

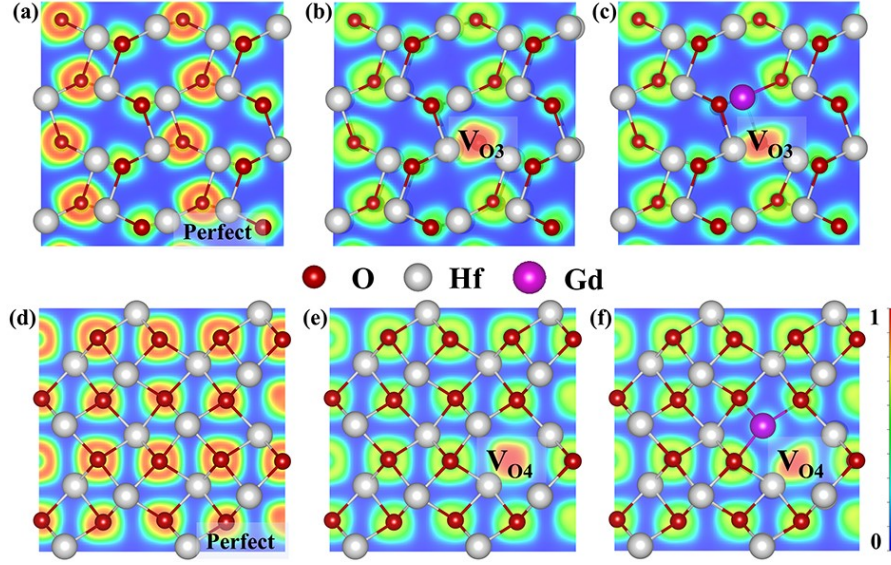


Fig. S4 Electron localization function (ELF) distributions of (a) and (d) perfect m -HfO₂, (b) m -HfO₂ containing single V_{O3}, (c) Gd-doped m -HfO₂ containing single V_{O3}, (e) m -HfO₂ containing single V_{O4}, and (f) Gd-doped m -HfO₂ containing single V_{O4}.

Table S1 Comparative analysis of the characterization for different metal-doped RRAM devices

Systems	Method	Generation of V _O	Randomicity of V _O formation	Migration barrier of V _O	Coulombic interaction	Stability of device
Gd-doped HfO ₂	GGA ¹	↑	↓	—	↑	↑
Gd-doped HfO ₂	GGA+U ²	↑	—	—	↑	—
Gd-doped HfO ₂	Exp. ³	—	↓	↓	—	↑
Gd-doped Ta ₂ O _{5-x}	Exp. ⁴	↓	—	↑	—	↑
Mg-doped HfO _x	Exp. and GGA-1/2 ⁵	↑	—	↑	—	↑
This work	GGA+U	↑	↓	↑	↑	↑

Meaning of symbols:

V_O represents oxygen vacancy; “↑” represents promotion (enhancement); “↓” represents suppression (reduction); “—” represents not clearly mentioned.

References

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